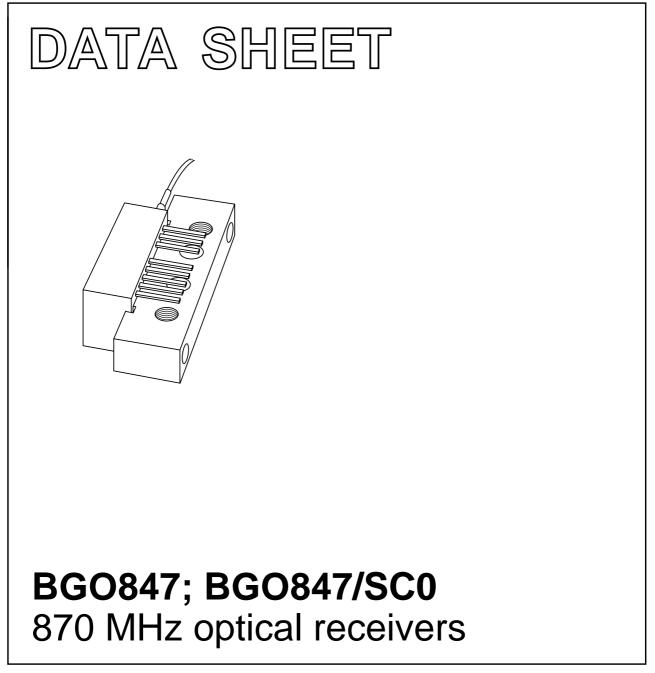
# DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2002 May 17 2002 Dec 10



### FEATURES

- Excellent linearity
- Extremely low noise up to 870 MHz
- Excellent flatness (straight line)
- Standard CATV outline
- Rugged construction
- Gold metallization ensures
  excellent reliability
- High optical input power range.

#### **APPLICATIONS**

• CATV optical node systems operating in the 40 to 870 MHz frequency range.

### DESCRIPTION

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fibre has either no connector or an SC/APC connector.

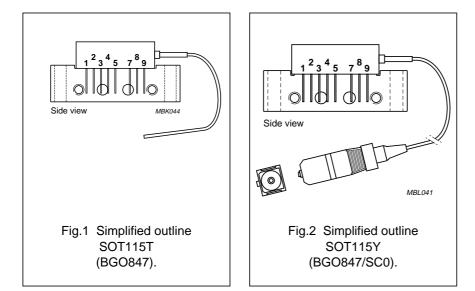
The amplifier supply voltage pin and the photo diode bias voltage pin both connect to 24 V (DC).

The modules have a monomode optical input suitable for 1290 to 1600 nm wavelengths, a terminal to monitor the photo diode current and an electrical output having a characteristic impedance of 75  $\Omega$ .

### BG0847; BG0847/SC0

### PINNING

PIN	DESCRIPTION			
1	monitor current			
2 common				
3	common			
4	+V <sub>B</sub> of the photo diode			
5 +V <sub>B</sub> of the amplifier				
7 common				
8 common				
9 output				



#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
f	frequency range		40	870	MHz
\$ <sub>22</sub>	output return losses	f = 40 to 870 MHz	11	_	dB
	optical input return losses		45	-	dB
d <sub>2</sub>	second order distortion	f = 854.5 MHz	-	-63	dB
F	equivalent noise input	f = 40 to 750 MHz	_	7	pA/√Hz
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	175	205	mA

#### CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

# BGO847; BGO847/SC0

### HANDLING

Fibreglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
f	frequency range		40	870	MHz
T <sub>stg</sub>	storage temperature		-40	+85	°C
T <sub>mb</sub>	operating mounting base temperature		-20	+85	°C
Pin	optical input power	continuous	-	5	mW
ESD	ESD sensitivity	human body model; R = 1.5 k $\Omega$ ; C = 100 pF	500	_	V

### CHARACTERISTICS

Bandwidth 40 to 870 MHz; V\_B = 24 V; T\_mb = 30 °C; Z\_L = 75  $\Omega.$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
S	responsivity					
	BGO847	$\lambda = 1300 \text{ nm}$	800	_	_	V/W
	BGO847/SC0	$\lambda = 1300 \text{ nm}$	750	-	_	V/W
FL	flatness straight line	peak to valley; f = 40 to 870 MHz	_	_	1	dB
SL	slope straight line	f = 40 to 870 MHz	0	_	2	dB
\$ <sub>22</sub>	output return losses	f = 40 to 870 MHz	11	-	_	dB
	optical input return losses		45	_	_	dB
d <sub>2</sub>	second order distortion	f <sub>m</sub> = 54 MHz; notes 1 and 3	-	_	-73	dB
		f <sub>m</sub> = 446.5 MHz; notes 1 and 4	-	-	-68	dB
		f <sub>m</sub> = 548.5 MHz; notes 1 and 5	_	_	-67	dB
		f <sub>m</sub> = 746.5 MHz; notes 1 and 6	-	-	-63	dB
		f <sub>m</sub> = 854.5 MHz; notes 1 and 7	-	-	-63	dB
$\Delta d_2$	second order distortion difference	$d_2$ at $T_{mb}$ = 85 °C – $d_2$ at $T_{mb}$ = 30 °C	-	2.5	-	dB
		$d_2$ at $T_{mb} = -20 \text{ °C} - d_2$ at $T_{mb} = 30 \text{ °C}$	_	-1.5	-	dB
d <sub>3</sub>	third order distortion	f <sub>m</sub> = 55.25 MHz; notes 2 and 8	-	_	-80	dB
		f <sub>m</sub> = 445.25 MHz; notes 2 and 9	_	_	-75	dB
		f <sub>m</sub> = 547.25 MHz; notes 2 and 10	_	_	-75	dB
		f <sub>m</sub> = 745.25 MHz; notes 2 and 11	-	-	-75	dB
		f <sub>m</sub> = 853.25 MHz; notes 2 and 12	_	_	-73	dB
$\Delta d_3$	third order distortion difference	$d_3$ at $T_{mb}$ = 85 °C – $d_3$ at $T_{mb}$ = 30 °C	-	1	-	dB
		$d_3 \text{ at } T_{mb} = -20 \ ^\circ C - d_3$ at $T_{mb} = 30 \ ^\circ C$	_	-1	-	dB

### BGO847; BGO847/SC0

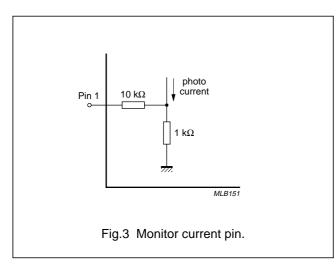
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
F	equivalent input noise	f = 40 to 750 MHz	-	-	7	pA/√Hz
		f = 750 to 870 MHz	-	-	8	pA/√Hz
s <sub>λ</sub>	spectral sensitivity	$\lambda = 1310 \pm 20 \text{ nm}$	0.85	-	-	A/W
		$\lambda = 1550 \pm 20 \text{ nm}$	0.9	-	-	A/W
λ	optical wavelength		1290	-	1600	nm
L	length of optical fibre					
	BGO847	fibre; SM type; 9/125 μm	1	-	_	m
	BGO847/SC0	fibre; SM type; 9/125 μm	746	-	861	mm
I <sub>tot</sub>	total current consumption (DC)	$T_{mb} = -20 \text{ °C to } +85 \text{ °C}$	175	-	205	mA
I <sub>bias</sub>	diode bias current at pin 4 (DC)		-	-	25	mA

#### Notes

1. Two laser test; each laser with 40% modulation index; Popt = 1 mW (total).

2. Three laser test; each laser with 60% modulation index; Popt = 1 mW (total).

- 3.  $f_m = 54$  MHz;  $f_p = 187.25$  MHz;  $f_q = 133.25$  MHz.
- 4.  $f_m = 446.5 \text{ MHz}; f_p = 97.25 \text{ MHz}; f_q = 349.25 \text{ MHz}.$
- 5.  $f_m = 548.5 \text{ MHz}$ ;  $f_p = 109.25 \text{ MHz}$ ;  $f_q = 439.25 \text{ MHz}$ .
- 6.  $f_m = 746.5 \text{ MHz}$ ;  $f_p = 133.25 \text{ MHz}$ ;  $f_q = 613.25 \text{ MHz}$ .
- 7.  $f_m = 854.5 \text{ MHz}$ ;  $f_p = 133.25 \text{ MHz}$ ;  $f_q = 721.25 \text{ MHz}$ .
- 8.  $f_m = 55.25$  MHz;  $f_p = 109.25$  MHz;  $f_q = 133.25$  MHz  $f_r = 187.25$  MHz.
- 9.  $f_m = 445.25$  MHz;  $f_p = 193.25$  MHz;  $f_q = 349.25$  MHz  $f_r = 97.25$  MHz.
- 10.  $f_m$  = 547.25 MHz;  $f_p$  = 217.25 MHz;  $f_q$  = 439.25 MHz  $f_r$  = 109.25 MHz.
- 11.  $f_m$  = 745.25 MHz;  $f_p$  = 133.25 MHz;  $f_q$  = 265.25 MHz  $f_r$  = 613.25 MHz.
- 12.  $f_m$  = 853.25 MHz;  $f_p$  = 133.25 MHz;  $f_q$  = 265.25 MHz  $f_r$  = 721.25 MHz.



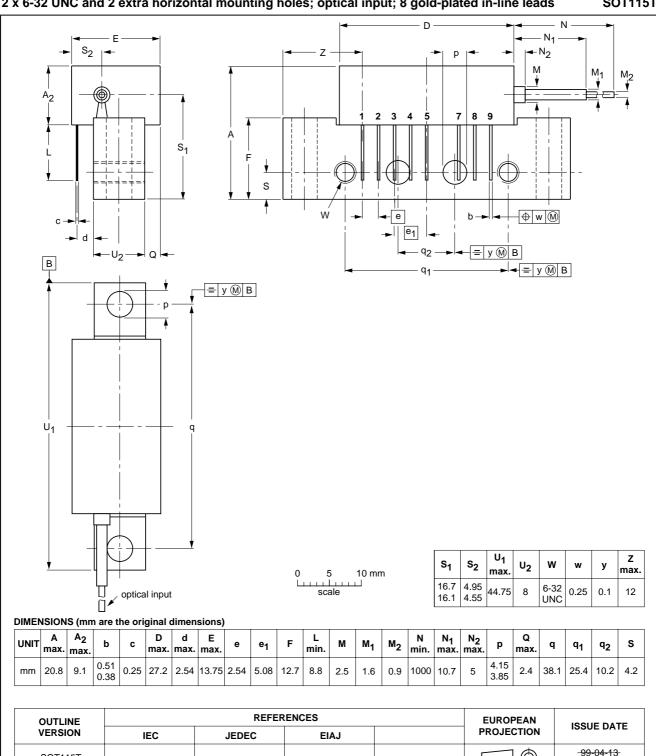
### BGO847; BGO847/SC0

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### PACKAGE OUTLINES

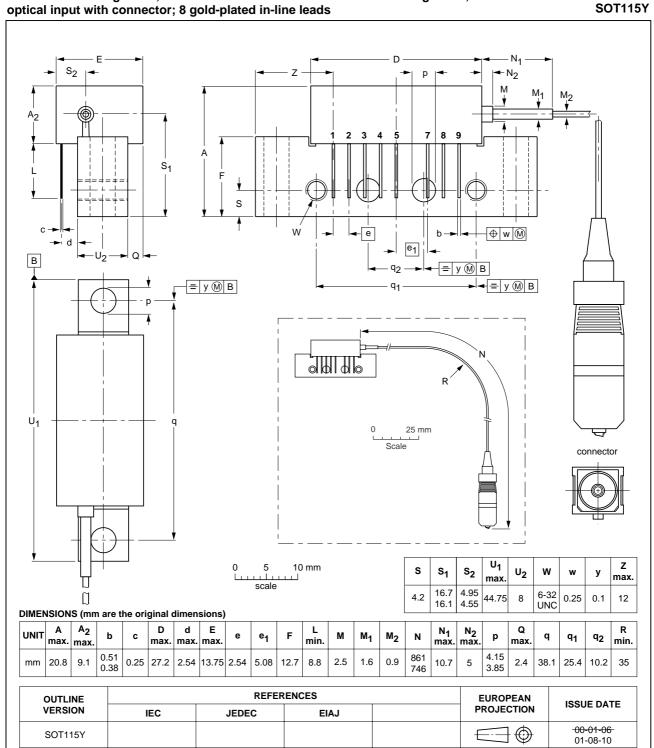


### Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads

**SOT115T** 

SOT115T

BGO847; BGO847/SC0



#### Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

2002 Dec 10

### BGO847; BGO847/SC0

### DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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